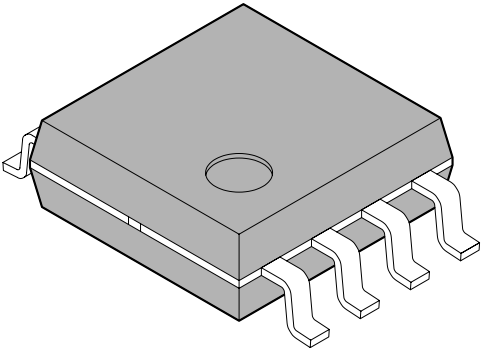
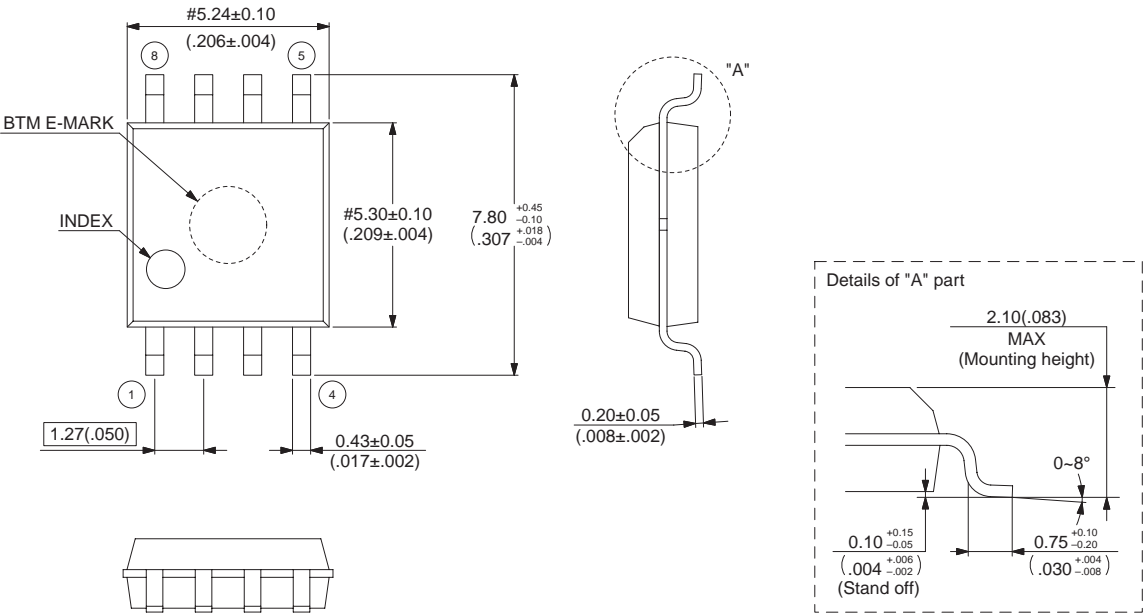


FPT-8P-M08

<p>8-pin plastic SOP</p>  <p>(FPT-8P-M08)</p>	Lead pitch	1.27 mm
	Package width × package length	5.30 mm × 5.24 mm
	Lead shape	Gullwing
	Lead bend direction	Normal bend
	Sealing method	Plastic mold
	Mounting height	2.10 mm Max

8-pin plastic SOP
(FPT-8P-M08)

Note 1) Pins width and pins thickness include plating thickness.
Note 2) Pins width do not include tie bar cutting remainder.
Note 3) # : These dimensions do not include resin protrusion.



Top view dimensions:
 Pin pitch: #5.24±0.10 (.206±.004)
 Pin 1 to Pin 4 distance: 1.27(.050)
 Pin 4 to Pin 8 distance: 0.43±0.05 (.017±.002)
 Package width: #5.30±0.10 (.209±.004)
 Package length: 7.80^{+0.45}_{-0.10} (.307^{+0.018}_{-0.004})

Side view dimensions:
 Pin thickness: 0.20±0.05 (.008±.002)

Details of "A" part:
 Mounting height: 2.10(.083) MAX
 Stand off: 0.10^{+0.15}_{-0.05} (.004^{+0.006}_{-0.002})
 Lead thickness: 0.75^{+0.10}_{-0.20} (.030^{+0.004}_{-0.008})
 Lead angle: 0~8°

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Dimensions in mm (inches).
Note: The values in parentheses are reference values.

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